



Product Change Notification

112915 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 112915 - 00
Change Title: Intel® Centrino® Advanced-N 6235 SKUs:
 6235AN.HMWG; 6235AN.HMWWB;
 6235AN.NGWG; 6235AN.HMWGBR
 PCN 112915-00, Product Material, Label
 PCB Material Change and Label Update
Date of Publication: March 4, 2014

Key Characteristics of the Change:

Product Material, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Apr 02, 2014
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Description of Change to the Customer:

The Intel® Centrino® Advanced-N 6235 SKUs listed in this PCN will undergo the following changes:

1. The current printed circuit board FR4 material S1155 has been discontinued and will be replaced by S1150G. S1150G has passed UL certification and was determined to be equivalent to S1155. S1150G has been fully qualified and all 2014 released products were developed with S1150G. The only impact is a change to the UL Marking on some of the PCB suppliers.
2. Update Carton Label Weight - from 3.6 to 1.2 lbs. on the distribution label.

Example of the change in Disti label



The above label is representation for example purposes only. The actual label will reflect correct product data.

3. The Intel Tracking Number on the product label for 6235AN.HMWG will change as follows:

Product Code	Old	New
6235AN.HMWG	0B	0C

Customer Impact of Change and Recommended Action:

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

For your information only. No change to form fit or function. No change to Intel Ordering codes.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
6235AN.HMWG	917561	G25304-011	G25304-012
6235AN.HMWWB	920119	G55001-002	G55001-003
6235AN.HMWGBR	924062	G73810-001	G73810-002
6235AN.NGWG	928344	G80129-002	G80129-003

PCN Revision History:

Date of Revision:

March 4, 2014

Revision Number:

00

Reason:

Originally Published PCN